

Description

The SJPL-L2 is a fast recovery diode of 200 V / 3.0 A. The maximum t_{rr} of 50 ns is realized by optimizing a life-time control.

Features

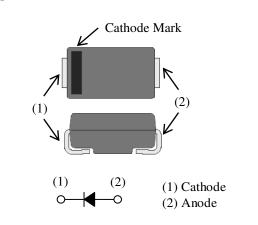
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0
- Suitable for High Reliability and Automotive Requirement.



- White Goods
- Audiovisual Equipment
- Lighting Equipment
- Industrial Electronic Equipment
- (Communication Equipment and Factory Automation) • Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

SJP



Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$				
Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V _{RSM}		200	V
Repetitive Peak Reverse Voltage	V _{RM}		200	V
Average Forward Current	I _{F(AV)}	See Figure 2 and Figure 3	3.0	А
Surge Forward Current	I _{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	60	А
I ² t Limiting Value	I ² t	$1 \text{ ms} \le t \le 10 \text{ ms}$	18	A ² s
Junction Temperature	TJ		-40 to 150	°C
Storage Temperature	T _{STG}		-40 to 150	°C

Unless otherwise specified, $T_A = 25 \ ^{\circ}C$.

Electrical Characteristics

Unless otherwise specified, $T_A = 25$	°C.					
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop	N	$T_J = 25 \ ^{\circ}C, I_F = 3.0 \ A$		_	0.98	V
	V_{F}	$T_J = 100 \text{ °C}, I_F = 3.0 \text{ A}$		0.74		V
Reverse Leakage Current	I _R	$V_R = V_{RM}$			50	μA
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 \ ^\circ C$			300	μA
Reverse Recovery Time	t _{rr1}	$I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$		_	50	ns
	t _{rr2}	$I_{F} = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ 75% recovery point, $T_{J} = 25 \text{ °C}$			35	ns
Thermal Resistance ⁽¹⁾	$R_{th(J-L)}$				20	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Package Weight		_	0.072	_	g

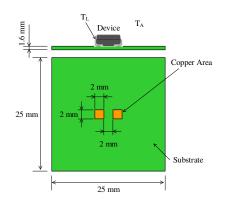


Figure 1. Lead Temperature Measurement Conditions

 $^{^{(1)}}$ R_{th (J-L)} is thermal resistance between junction and lead. Lead temperature (T_L) is measured near the root of pin (see Figure 1).

Derating Curves

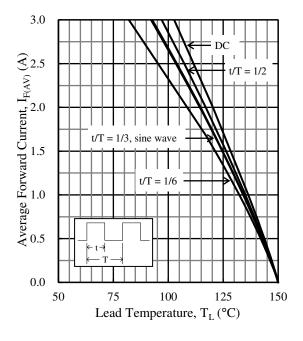


Figure 2. $I_{F(AV)}$ vs. $T_L (T_J = 150 \text{ °C}, V_R = 0 \text{ V})$

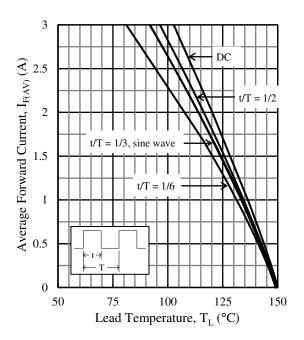


Figure 3. $I_{F(AV)}$ vs. $T_L (T_J = 150 \text{ °C}, V_R = 200 \text{ V})$

Characteristic Curves

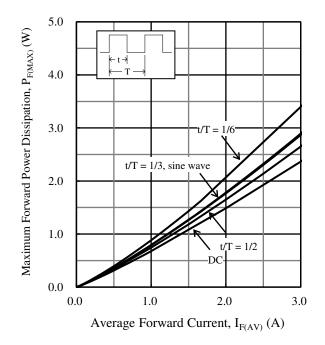


Figure 4. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150 \text{ °C}$)

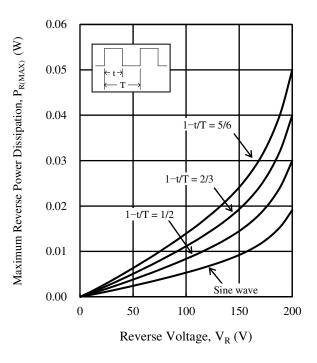
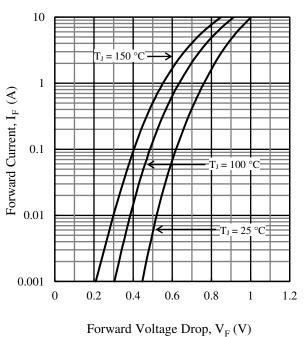
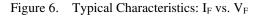


Figure 5. $P_{R(MAX)}$ vs. V_R ($T_J = 150 \ ^{\circ}C$)





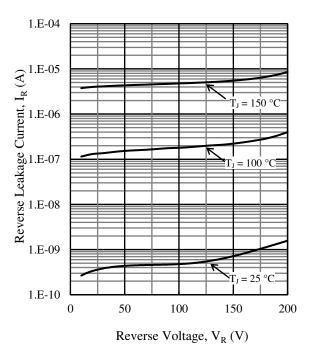


Figure 7. Typical Characteristics: I_R vs. V_R

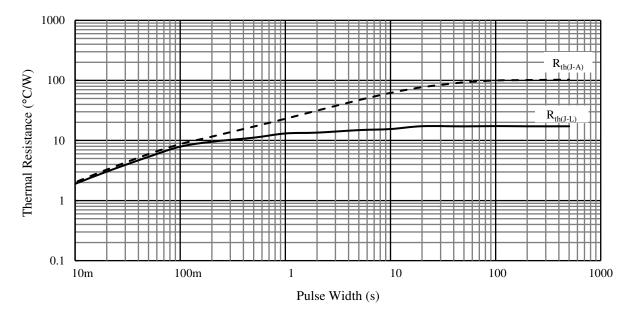
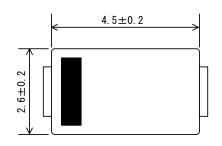
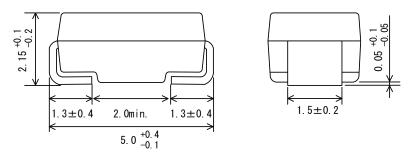


Figure 8. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• SJP Package



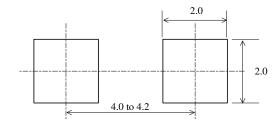


NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- Moisture Sensitivity Level 1 (MSL 1)
- When soldering the products, it is required to minimize the working time within the following limits: Flow: 260 °C / 10 s, 1 time

Reflow: Preheat: 150 °C to 200 °C / 60 s to 120 s Solder heating: 255 °C / 30s, 3 times (260 °C peak) Soldering Iron: 350 °C / 3.5 s, 1 time

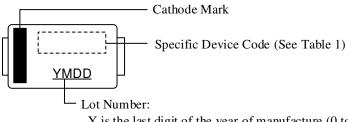
• SJP Land Pattern Example



NOTE:

- Dimensions in millimeters

Marking Diagram



Y is the last digit of the year of manufacture (0 to 9) M is the month of the year (1 to 9, O, N, or D) DD is the day of the month (01 to 31)

Table 1. Specific Device Code

Specific Device Code	Part Number
LL2	SJPL-L2

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